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(54) **LIGHT-EMITTING SUBSTRATE AND
LIGHT-EMITTING DEVICE**

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ABSTRACT

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The present disclosure provides a light-emitting substrate and a light-emitting device. The light-emitting substrate includes: a first electrode layer on a base substrate; a pixel definition layer arranged on a part of the first electrode layer and a part of the base substrate not covered by the first electrode layer, the pixel definition layer including at least two pixel definition aperture regions and a non-pixel aperture region other than the pixel definition aperture regions, the non-pixel aperture region being arranged with a groove on a side surface away from the base substrate, and a first thermally-conductive member being arranged in the groove; a first functional layer, a light-emitting layer and a second functional layer arranged in the pixel definition aperture regions; and a second electrode covering the second functional layer and the pixel definition layer, the second electrode being coupled to the first thermally-conductive member.

